US1x Series



RoHS

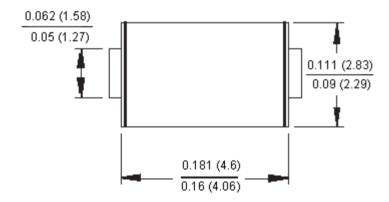
Compliant

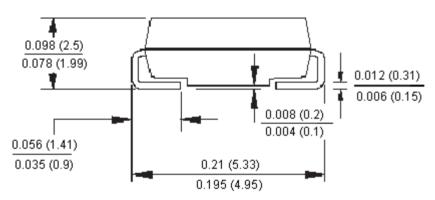


Features:

- Glass passivated junction chip
- For surface mounted application
- Low profile package
- Built-in strain relief
- · Ideal for automated placement
- · Easy pick and place
- Ultrafast recovery time for high efficiency
- Low forward voltage, low power loss
- High temperature soldering guaranteed : 260°C/10 seconds on terminals
- Plastic material

SMB/DO-214AC





Dimensions : Inches (Millimetres)

Mechanical Data

Cases : Moulded plastic

Terminals : Solder plated solderable per MIL-STD-750, Method 2026

Polarity : Indicated by cathode band

Weight : 0.064 g







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Maximum Ratings and Electrical Characteristics

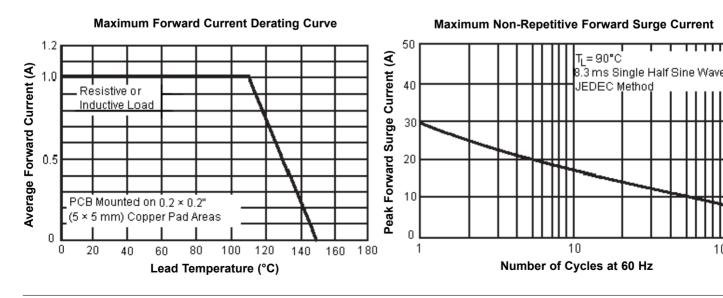
Rating at 25°C ambient temperature unless otherwise specified Single phase, half wave, 60 Hz, resistive or inductive load For capacitive load, derate current by 20%

Type Number	Symbol	US1A	US1B	US1D	US1G	US1J	US1K	US1M	Units
Maximum Recurrent Peak Reverse Voltage	V _{RRM}	50	100	200	400	600	800	1,000	
Maximum RMS Voltage	V _{RMS}	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V _{DC}	50	100	200	400	600	800	1,000	
Maximum Average Forward Rectified Current at $T_L = 110$ °C	I (AV)	1							
Peak Forward Surge Current, 8.3 ms Single Half Sine-wave Superimposed on Rated Load (JEDEC Method)	I _{FSM}	30						A	
Maximum Instantaneous Forward Voltage at 1 A	V _F	1 1.7						V	
Maximum DC Reverse Current at $T_A = 25$ °C at Rated DC Blocking Voltage at $T_A = 125$ °C	I _R	5 150						μA	
Maximum Reverse Recovery Time (Note 1)	T _{rr}	50			75		pF		
Typical Junction Capacitance (Note 2)	C _j	15 10				°C/W			
Maximum Thermal Resistance (Note 3)	$R_{ heta J A}$	75 27							
Operating Temperature Range	T _J		-55 to +150						°C
Storage Temperature Range	T _{STG}	-55 to +150							

Notes : 1. Reverse Recovery Test Conditions: I_F = 0.5 A, I_R = 1 A, I_{RR} = 0.25 A

- 2. Measured at 1MHz and Applied V_R = 4 Volts
- 3. PCB Mounted on 0.2 × 0.2 inches (5 × 5 mm) Copper Pad Area

Ratings and Characteristic Curves (US1A, US1B, US1D, US1G, US1J, US1K, US1M)



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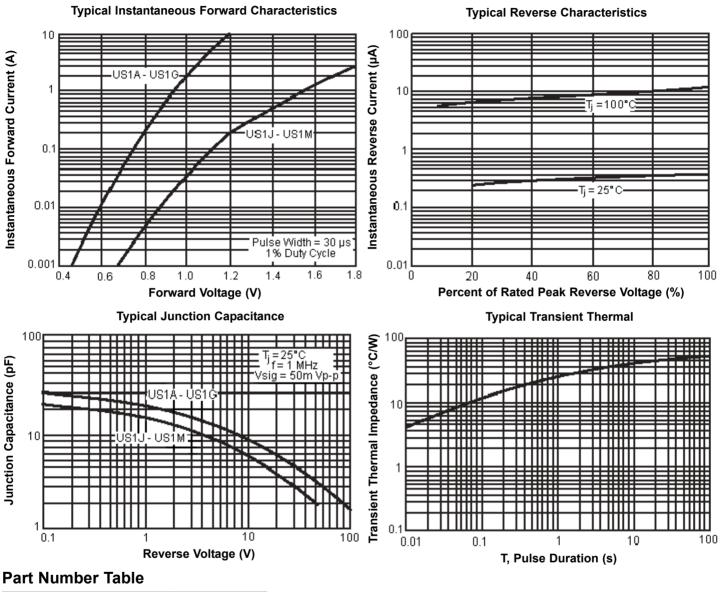


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US1x Series



Ratings and Characteristic Curves (US1A, US1B, US1D, US1G, US1J, US1K, US1M)



Description	Part Number				
Diode, Ultra-Fast, 1A, 50V	US1A				
Diode, Ultra-Fast, 1A, 100V	US1B				
Diode, Ultra-Fast, 1A, 200V	US1D				
Diode, Ultra-Fast, 1A, 400V	US1G				
Diode, Ultra-Fast, 1A, 600V	US1J				
Diode, Ultra-Fast, 1A, 800V	US1K				
Diode, Ultra-Fast, 1A, 1,000V	US1M				

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